PORM PTU-: 695	RECORDATION FORM	COVER SHEET U.S. Departments of Compares Patent And Testerank softing		
(Row, 8-91) CHE NO. 0651-0081 (Map. 4/94)	PATENTS			
To the Honorable Commissioner of Patents and Trade	marks: Please record the atta	sched original document or copy thereof.		
1. Name of conveying party(ies):		2. Name and address of receiving party(ies):		
HIMANSHU J. CHOKSHI BEN JU ERIC J. HILTON  Additional name(s) of conveying party(ies) attached?  3. Nature of conveyance: X AssignmentMerget		Name: Applied Materials, Inc.  Internal Address: P.O. Box 450-A  Street Address:  City: Santa Clara State: CA zip: 95052		
Security Agreement Chang	ge of Name	Additional name(s) & address(es) attached? Yes _X_ No		
Execution Date: SEE ABOVE		· ·		
4. Application number(s) or registration number(s):  If this document is being filed together with a new application, the execution date of the application is:  (Date of Filing)  A. Patent Application No.(s) 09/562,252 FILED ON MAY 2, 2000  B. Patent No.(s)  Additional numbers attached? Yes X No				
<ol> <li>Name and address of party to whom corresponden document should be mailed;</li> </ol>	nce concerning	6. Total number of applications and patents involved:1		
Name: Patent Counsel		7. Total fee (37 C.F.R. 3.41) \$\ \text{Enclosed}\$		
Internal Address: APPLIED MATE	·	X Authorized to be charged to deposit account  50-1074		
Street Address: P.O. Box 450-A	<u> </u>	8. Deposit account number: 50-1074		
City: Santa Clara State: CA	zip: <u>95052</u>			
DO NOT USE THIS SPACE				
9. Statement and signature.  To the best of my knowledge and belief, the foregoing information is true and correct that any attached copy is a true copy of the original obcument.  ROBERT W. MULCAHY Reg. No. 25,436  Name of Person Signing  Total number of pages including cover sheet, attachments and document:				

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

### ASSIGNMENT FOR APPLICATION FOR PATENT

#### WHEREAS:

Names and Addresses of Inventors:

- Himanshu J. Chokshi
   38642 Pickering Court
   Fremont, California 94536
- 3) Eric J. Hilton 1402 Dentwood Drive San Jose, California 95118
- Ben Ju895 Alcosta Dr.Milpitas, California 95035

(hereinafter referred to as Assignors), have invented a certain invention entitled:

## SUBSTRATE LOADER FOR A SEMICONDUCTOR PROCESSING SYSTEM

for which application for Letters Patent in the United States was filed on 5/2/2000 under Serial No. 09/362,252, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said

PATENT REEL: 010974 FRAME: 0498

Sep-22-00 12:49PM;

Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

- The term and covenants of this agreement shall inure to the benefit of said 3. Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignce on the dates indicated below.

1)	<u>8/18/</u> , 2000	Himanshu J. Chokshi
2)	, 2000	Ben Ju
3)	, 2000	Fric I Hilton

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: AMAT M\*A LEGAL;

### ASSIGNMENT FOR APPLICATION FOR PATENT

#### WHEREAS:

Names and Addresses of Inventors:

- 1) Himanshu J. Chokshi 38642 Pickering Court Fremont, California 94536
- 3) Eric J. Hilton 1402 Dentwood Drive San Jose, California 95118
- Ben Ju895 Aicosta Dr.Milpitas, California 95035

(hereinafter referred to as Assignors), have invented a certain invention entitled:

# SUBSTRATE LOADER FOR A SEMICONDUCTOR PROCESSING SYSTEM

for which application for Letters Patent in the United States was filed on  $\frac{5/2/2000}{1000}$  under Serial No.  $\frac{0.9/562,252}{1000}$ , executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

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- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said

PATENT REEL: 010974 FRAME: 0500

Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)		Himanshu J. Chokshi
2)	, 2000	Ben Ju
3)	Aug. 16, 2000	Eric J. Hilton

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': AMAT M\*A LEGAL;

## ASSIGNMENT FOR APPLICATION FOR PATENT

#### WHEREAS:

Names and Addresses of Inventors:

- 1) Himanshu J. Chokshi 38642 Pickering Court Fremont, California 94536
- Eric J. Hilton 3) 1402 Dentwood Drive San Jose, California 95118
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- Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said

1 of 2

Sep-22-00 12:50PM;

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- Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)		Himanshu J. Chokshi
2)		$\frac{R}{\text{Ben Ju}} \int \frac{0.8-31-3000}{0.8-31-3000}$
3)	, 2000	Eric J. Hilton

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: AMAT M\*A LEGAL;